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November 2013

DFB2505 - DFB25100 Glass-Passivated Bridge Rectifiers

Features

- UL Certificate: # E258596
- Glass-Passivated Junction
- Ideal for Printed Circuit Board
- Reliable Low-Cost Construction
- Plastic Material has Underwriters Laboratory Flammability Classification 94V-0
- Surge Overload Rating: 350 A Peak
- High Case Dielectric Strength: 2500 V_{RMS}
- Isolated Voltage from Case to Lead: > 2500 V



TS-6P

Ordering Informations

Part Number	Marking	Package	Packing Method
DFB2505	DFB2505	TS-6P 4L	Rail
DFB2510	DFB2510		
DFB2520	DFB2520		
DFB2540	DFB2540		
DFB2560	DFB2560		
DFB2580	DFB2580		
DFB25100	DFB25100		

Absolute Maximum Ratings⁽¹⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value							Unit
		DFB25 05	DFB25 10	DFB25 20	DFB25 40	DFB25 60	DFB25 80	DFB25 100	
V_{RRM}	Maximum Recurrent Peak Reverse Voltage	50	100	200	400	600	800	1000	V
V_{RMS}	Maximum RMS Voltage	35	70	140	280	420	560	700	V
V_{DC}	Maximum DC Blocking Voltage	50	100	200	400	600	800	1000	V
$I_{(AV)}$	Maximum Average Forward Rectified Current	25							A
I_{FSM}	Peak Forward Surge Current (8.3 ms Single Half-wave)	350							A
$R_{\theta JC}$	Typical Thermal Resistance ⁽²⁾	4.75							$^\circ\text{C}/\text{W}$
T_J	Operating Temperature Range	-55 to +150							$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to +150							$^\circ\text{C}$

Notes:

1. Single-phase, half-wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.
2. Device mounted on 4 inch x 6 inch x 0.25 inch Al-plate heat sink.

Electrical Characteristics

Values are at $T_A = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Value	Unit
V_F	Maximum Forward Voltage	12.5 A	1.0	V
	Instantaneous Forward Voltage	25 A	1.1	
I_R	Maximum DC Reverse Current at Rated DC Blocking Voltage	$T_A = 25^\circ\text{C}$	10	μA
		$T_A = 125^\circ\text{C}$	500	
I^2t	Rating for fusing ($t < 8.3$ ms)		508	A^2s
C_J	Typical Junction Capacitance per Leg ⁽³⁾		110	pF

Note:

3. Measured at 1 MHz and applied reverse bias of 4.0 V DC.

Typical Performance Characteristics

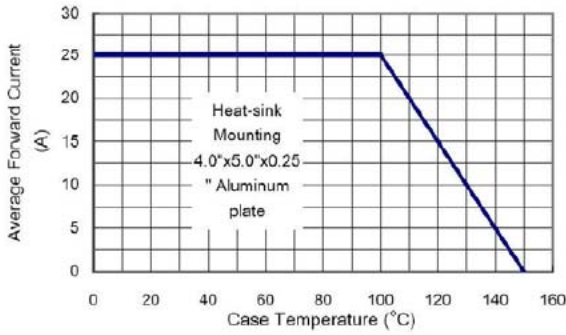


Figure 1. Maximum Derating Curve for Output Current

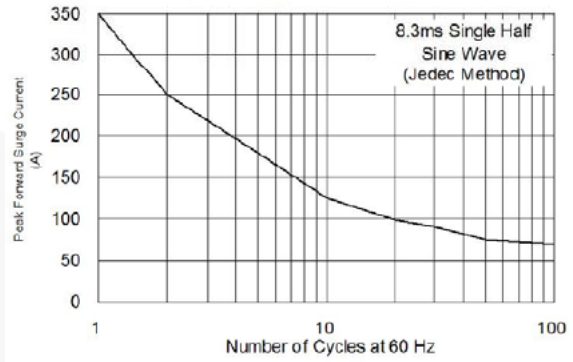


Figure 2. Maximum Forward Surge Current

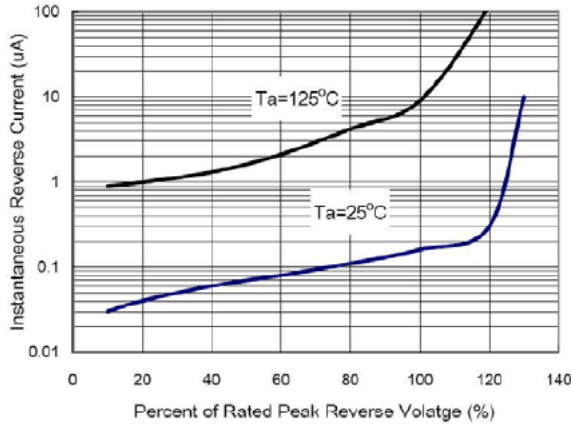


Figure 3. Typical Reverse Characteristics per Leg

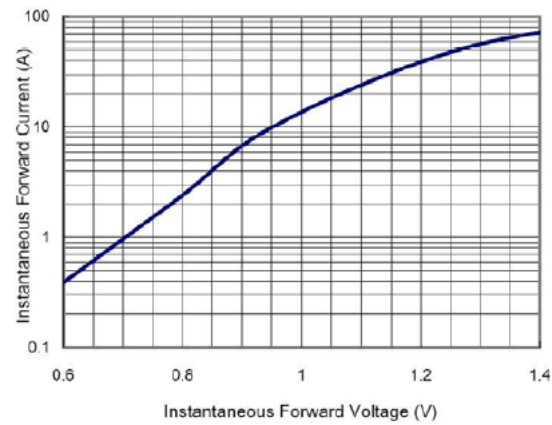


Figure 4. Typical Forward Characteristics per Leg

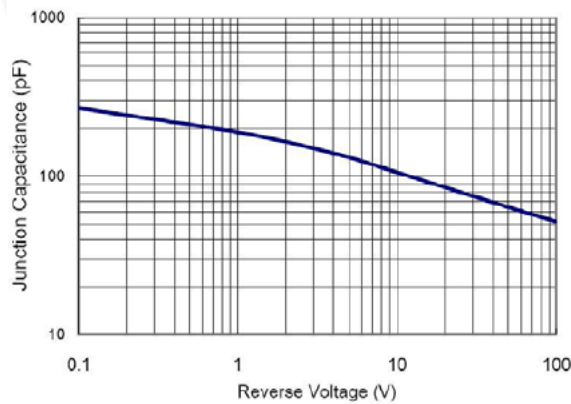


Figure 5. Typical Junction Capacitance



NOTES:

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- B. ALL DIMENSIONS ARE IN MILLIMETERS.
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